
SPECIFICATIONS FOR Jiangxi Hong Li Opto-Electronic

江西鸿利光电规格书

TOP SL-*B2835FAB-11CAEH series

2835 高显白光系列

Customer 客户确认	Approved 批准	Checked 审核	Prepared 编制

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Descriptions 说明

Our 2835 products, use silica gel solid crystal and silica gel packages, effectively improve the heat dissipation performance. Reliability is better than companies in general, it is a complete white combination with high brightness, low-light decay characteristics.

我们的 2835 产品使用硅胶封装,有效地提高了散热的性能.可靠性优于同类产品,亮度高,颜色一致性好,低光衰。



Features

- Size (mm) 3.5*2.8*0.7
- Viewing angle: 120°
- ROHS compliant lead-free soldering compatible
- Warm/White:
- A typical color temperature:
2700K/3000K/3500K/4000K/
4500K/5000K/5700K/6500K

特点

- 外观尺寸 (mm) 3.5*2.8*0.7
- 发光角度: 120°
- 符合 ROHS 无铅焊接的标准
- 暖白/白光:
- 典型色温:
2700K/3000K/3500K/4000K/
4500K/5000K/5700K/6500K

Applications

- Channel letter
- Portable lighting
- Decorative lighting
- OA equipment
- Backlighting of full color LCD
- Bulbs and fluorescent lamps

应用

- 指示灯
- 便携照明
- 装饰照明
- 办公照明
- 液晶背光
- 家居照明

Mass Production List 批量生产目录

Product Name 产品型号	CCT	Ra Min	Φ (lm) Min	Φ (lm) Max	Test conditions 测试条件
SL-IB2835FAB-11CAEH	2700	80	22	25	25°C, IF=60mA
SL-IB2835FAB-11CAEH	3000	80	23	26	
SL-IB2835FAB-11CAEH	3500	80	23	26	
SL-NB2835FAB-11CAEH	4000	80	23	26	
SL-NB2835FAB-11CAEH	4500	80	23	26	
SL-WB2835FAB-11CAEH	5000	80	25	28	
SL-WB2835FAB-11CAEH	5700	80	25	28	
SL-WB2835FAB-11CAEH	6500	80	25	28	

Notes:备注

- 1.Tolerance of Color Rendering Index: ± 2 . 显色指数公差 ± 2
- 2.Tolerance of Luminous flux: $\pm 5\%$. 光通量公差 $\pm 5\%$
3. Luminous flux BIN: 3 lm BIN: 光通量分 BIN 方式: 3LM 分 BIN

Absolute maximum ratings 最大限定参数(Ta=25°C)

Parameter 项目名称	Symbol 符号	Value 规格	Unit 单位
Power dissipation 消耗功率	Pd	204	mW
Forward current 正向电流	IF	80	mA
Reverse voltage 反向电压	VR	5	V
Operating temperature range 工作温度范围	Top	-35 ~+85	°C
Storage temperature range 储存温度范围	Tstg	-35 ~+85	°C
Heatresistance 热阻	Rth	38	°C/W
Junction temperature 结温	Tj	115	°C
Electrostatic Discharge 抗静电能力	ESD	2000	V

Electro-optical characteristics 主要光电参数(Ta=25℃)

Parameter 项目名称	Symbol 符号	Min	Typ	Max	Unit	Test Condition 测试条件
Forward voltage 正向电压	Vf	2.8		3.4	V	IF=60mA
Luminous flux 光通量	Φ	22			lm	IF=60mA
Viewing Angle 角度	2 θ 1/2		120		Deg	IF=60mA
Reverse current 反向电流	IR			10	μA	Vr=5V
Color Index 显色指数	Ra	80				IF=60mA

NOTES 注释:

- * The measurement of forward voltage maintains a tolerance of $\pm 0.05V$, flux maintains a tolerance of $\pm 5\%$.
- * 正向电压测量误差 $\pm 0.05V$ ，光通量 $\pm 5\%$ 。
- * Ra measurement tolerance is ± 2 .
- * Ra 测量误差为 ± 2 。
- * Rth j-sp is the thermal resistance from LED junction to solder point on MCPCB with electrical power.
- * Rth j-sp 是通电时从 PN 结到铝基板焊点的热阻。

Bin Range of Chromaticity Coordinate Bin 区分类及色坐标范围

Bin Code	CIE_X	CIE_Y	CCT 范围(K)
A27	0.4813	0.4319	2580-2870
	0.4562	0.426	
	0.4373	0.3893	
	0.4593	0.3944	
A30	0.4562	0.426	2870-3220
	0.4299	0.4165	
	0.4147	0.3814	
	0.4373	0.3893	
A35	0.4299	0.4165	3220-3705
	0.3996	0.4015	
	0.3889	0.369	
	0.4147	0.3814	
A40	0.4005	0.4044	3705-4260
	0.3736	0.3874	
	0.367	0.3578	
	0.3897	0.3716	
A45	0.3736	0.3874	4260-4740
	0.3548	0.3736	
	0.3512	0.3465	
	0.367	0.3578	
A50	0.3551	0.376	4740-5300
	0.3376	0.3616	
	0.3366	0.3369	
	0.3515	0.3487	
A57	0.3376	0.3616	5300-6050
	0.3207	0.3462	
	0.3222	0.3243	
	0.3366	0.3369	
A65	0.3205	0.3481	6060-7035
	0.3028	0.3304	
	0.3068	0.3113	
	0.3221	0.3261	

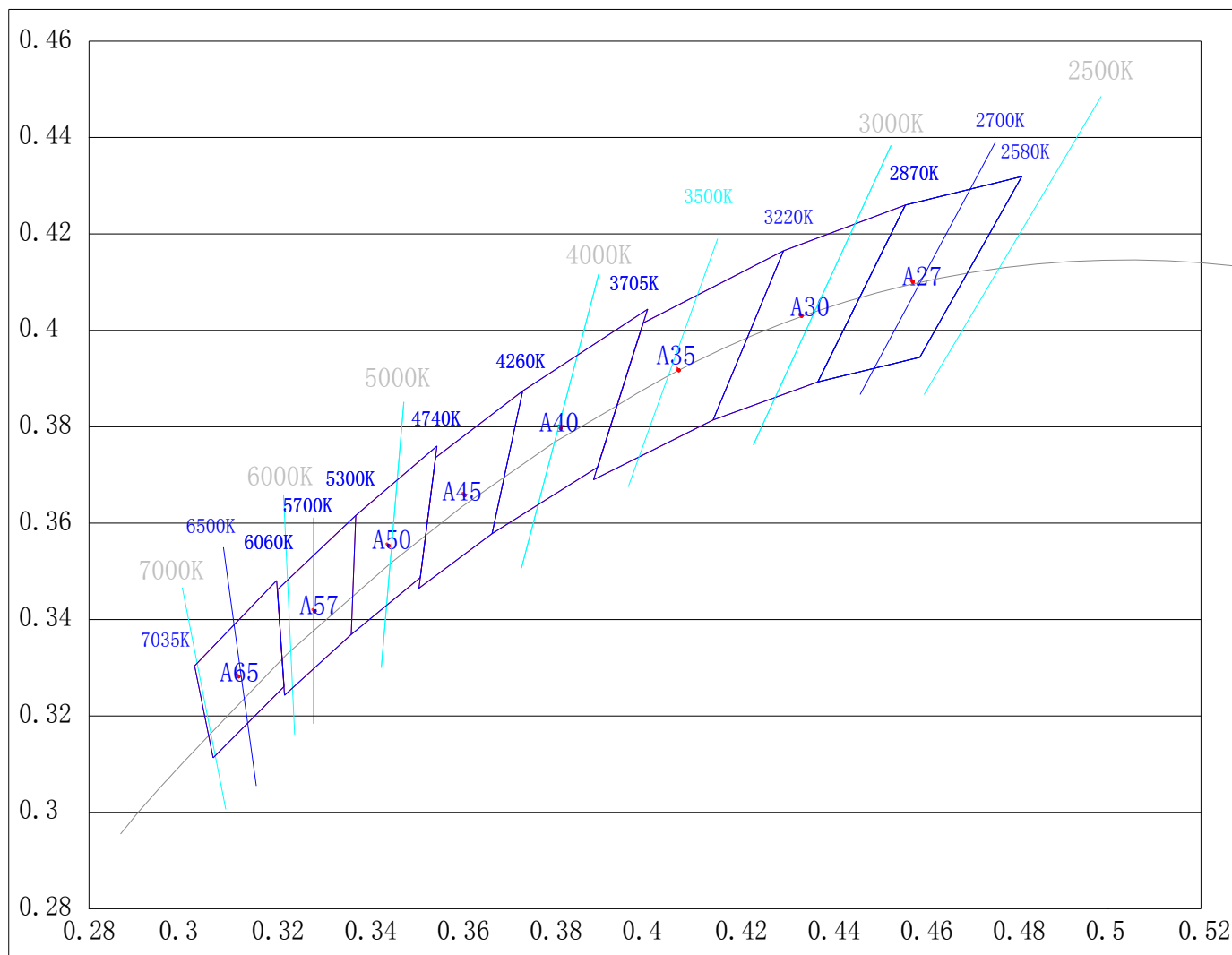
NOTES 注释

Test and binned at 25℃, IF=额定电流

Tester tolerance: ±0.01 in x and y coordinates

CIE Chromaticity Diagram

色区图



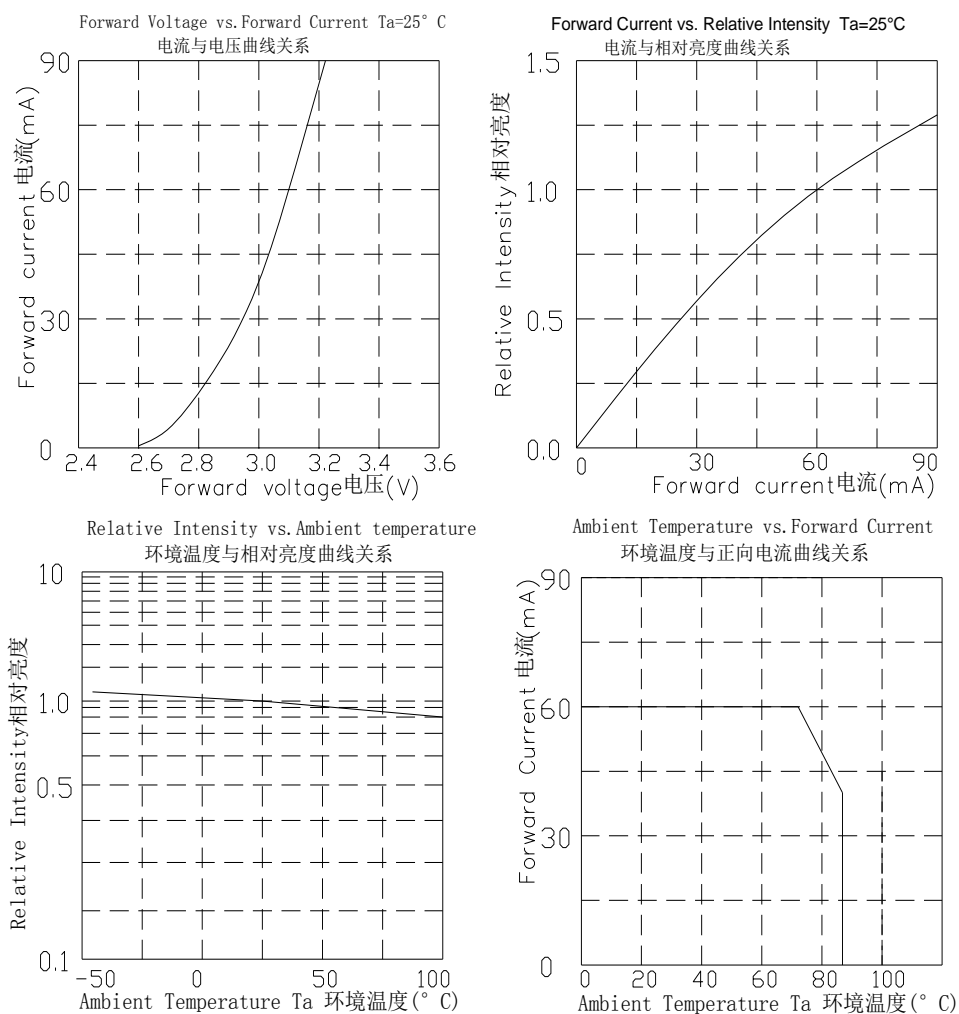
Reliability Test Items And Conditions 信赖性测试项目及条件

Test Items 测试项目	Test condition 测试条件	Time 时间	Quantity 数量	Ac/Re 接受、拒收
Reflow Soldering 回流焊	Temp. :260°C/10sec.	6Min.	22pcs	0/1
Thermal Shock 冷热冲击	-40~125C, 15min dwell, 10sec transfer	100Cycles	22pcs	0/1
High Temperature High Humidity life Test 高温高湿通电	85°C,85%RH, If=60mA	1000Hrs.	10pcs	0/1
Low Temperature Storage 低温保存	Ta=-40°C	1000Hrs.	10pcs	0/1
High Temperature Storage 高温保存	Ta=100°C	1000Hrs.	10pcs	0/1
High Temperature Operation Life Test 高温通电	Ta=85°C, If =60mA.	1000Hrs.	10pcs	0/1

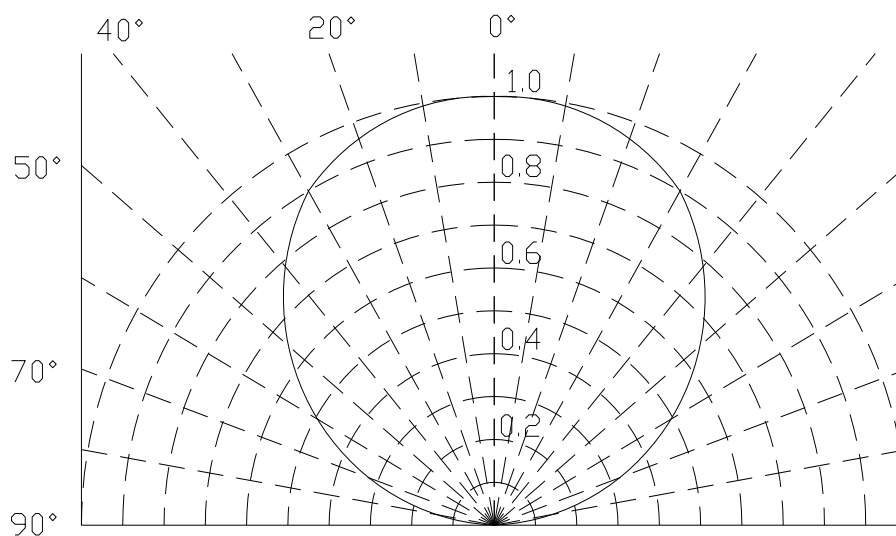
Failure Criteria 失效判断标准

Item 项目	Symbol 符号	Failure Criteria 判断标准
Luminous Flux 光通量	Lm	$\geq 80\%$
Forward voltage 正向电压	VF	$\pm 10\%$
Colour 坐标点	CIE_X CIE_y	± 0.01

Typical optical characteristics curves 光电特性曲线

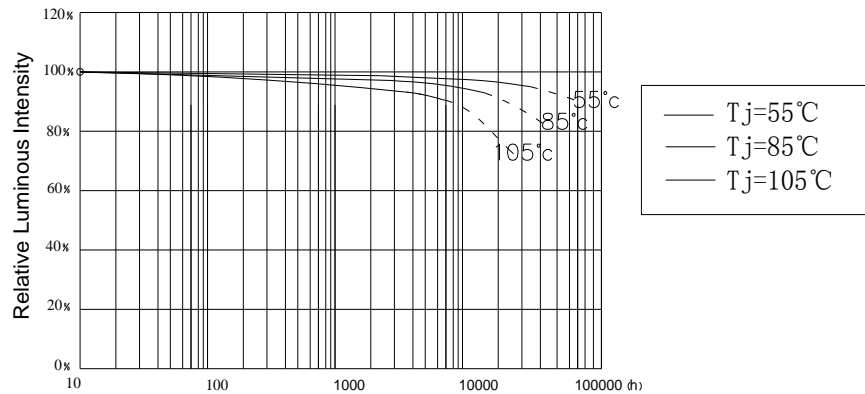


Curves of beam angle and relative brightness

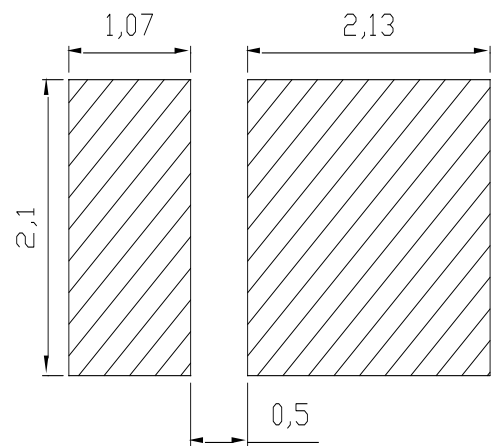
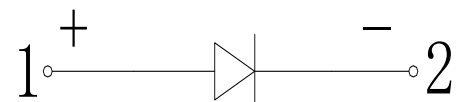
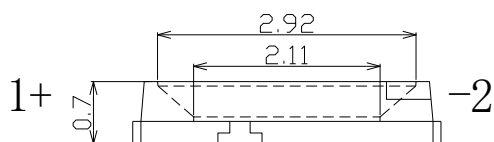
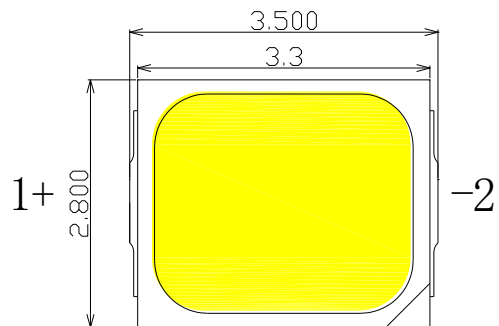


life test:

Affect of T_j on Luminous Maintenance
($I_f=60\text{mA}$)
(Dot line: Expected Life)

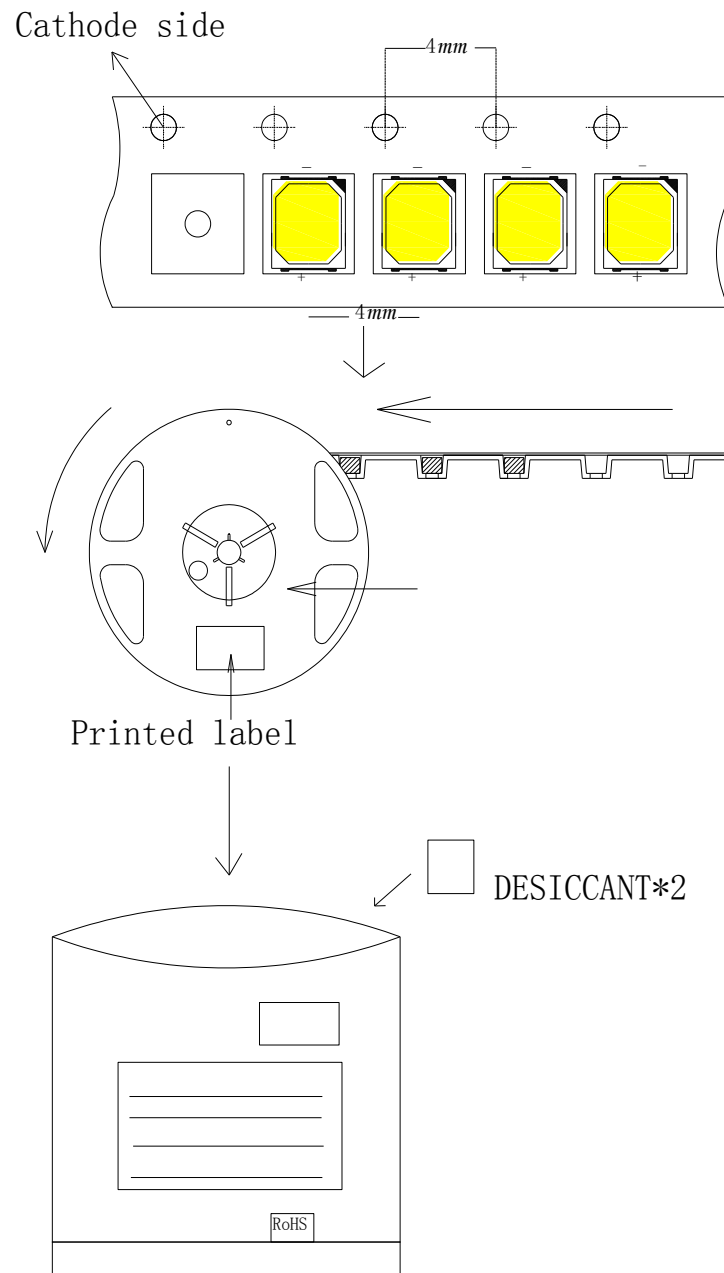


Mechanical Dimensions 外观尺寸: Unit 单位 (mm)



For reflow soldering 建议焊盘尺寸

Packaging 包装

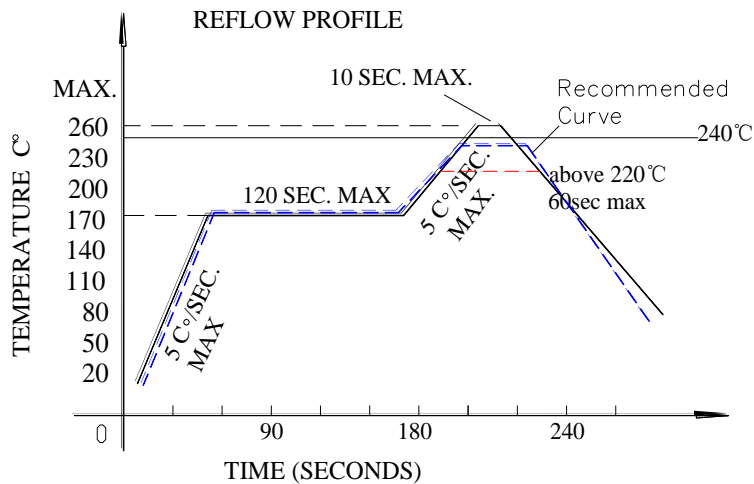


NOTES 备注:

1. Empty component pockets are sealed with top cover tape;
预留载带空位也贴有上封带
2. The maximum number of missing lamps is two;
最多缺失的 LED 不能超过两颗
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
根据 ANSI/EIA RS-481 的规格,产品的负极指向卷带的导孔.
4. 4,000 pcs / Reel.
4,000 颗/卷

Specifications 规格

一、 Requirements for application and reflow soldering 应用及回流焊要求:



Reflow soldering curve 回流焊曲线图

(Product is highest resistant to 260°C reflow but suggested the highest temperature of 240°C within)

(产品最高可耐260°C回流焊，但建议最高温度设为240°C)

■ Notes for reflow soldering 回流焊注意事项:

1. No more than twice for reflow soldering.
注意回流焊不可超过两次。
2. To ensure the quality of our LEDs, we encapsulate them with silica gels. So please do not put pressure on the LEDs.
为保证产 LED 质量及可靠性我司采用硅胶封装，胶体表面较软，焊接加热过程中，不可施加压力在 LED 表面。
3. Please choose the right nozzle(try to learn from the plastic products parts) to avoid the damage to products due to the pressure.
在吸嘴的选取上要选择吸嘴的大小和压力合适的吸嘴（尽量吸取产品的塑胶部分），以避免造成压力过大伤害产品。
4. Please put on the antistatic hand loop during the use. The worktable should be with antistatic finish. The equipments must be contacted with ground.
LED 为静电敏感产品，使用时请佩带防静电手环，工作台做好防静电处理，机台设备等保证接地。

■ Handwork soldering 手工焊接:

1. During the soldering, the electronic soldering iron must be kept under the temperature of 300°C and the soldering time must not be beyond 3 seconds. No touch between the electronic soldering iron and colloid.
手工焊接时，要保持电烙铁温度在 300 摄氏度以下，并且焊接时间小于 3 秒，电烙铁不可接触胶体。
2. Handwork soldering is only allowed once. We won't take responsibility for more than that.
手工焊接只可进行一次，重复焊接不保证产品是否完好。
3. Avoid using sharp objects to compress products Colloidal Part directly.
避免使用尖锐的物体直接接触产品胶体部分。
4. Please put on the antistatic hand loop during the use. The worktable should be with antistatic finish. The equipments must be contacted with ground.
LED 为静电敏感产品，使用时请佩带防静电手环，工作台做好防静电处理，机台设备等保证接地。

二、Storage conditions 储存条件

Before opening the package 打开包装袋前:

1. The LEDs can be preserved for 1 year in condition of temperature no more than 30℃ and humidity no more than 60%RH.
Recommended for moisture-proof foil bag with desiccant packaging methods and stored in the constant temperature and humidity box. Can not reach the requirements under the environment of the guarantee as far as possible in six months after use.
在温度不超过30℃及湿度不超过60%RH 条件下, LED 可以保存一年, 建议采用带干燥剂的防潮铝箔袋的包装方式, 存放在恒温恒湿箱中。达不到要求的环境下, 尽量保证在6个月内使用完毕。

After opening the package 打开包装后:

1. The SMD LEDs should be run out with 12hours in condition of temperature no more than 30℃ and humidity no more than 60%RH. The rest products should be pressurized in vacuum condition with desiccants. Stored for more than 7 days, next time also must be dehumidification, the dehumidification conditions is 70℃ with 12hours.
开封后, LED 在 $\leq 30^{\circ}\text{C}$, $\leq 60\%\text{RH}$ 相对湿度的条件下, 12 小时内完成贴片作业, 未用完的产品重新真空密封, 并放置在一个密封容器中, 同时必须使用干燥剂。存储超过7 天, 下次使用时同样需要除湿操作, 除湿条件为70℃ 12 小时。
2. The sealed storage products stock in the drying cabinet more for than one month, then must be dehumidified before used, and the dehumidified conditions is 70℃ 24 hours.
密封的产品在干燥箱中存储超过1个月的, 须经过深度除湿作业才能上线, 除湿条件: 70℃24小时。
3. If the product does not vacuum sealed packaging, and in the air for more than 40hours, this product must be removed from the tape of reel and put into the steel plate to dehumidify with 150℃ 2 hours, then could ensure the quality of the product after the soldering operation.
如果产品没有真空包装密封保存, 且在空气中放置超过40小时, 此产品必须从载带中拆出, 放入钢盘进行150℃2小时的除湿, 之后进行回流焊作业才能保证产品品质。